$T_{CASE} = -55^{\circ}C$ to $+85^{\circ}C$, $V_{IN} = +28V \pm 5\%$ unless otherwise specified

5,152		
Absolute Maximum Ratings		
Input voltage	-0.5V to +50VDC	
Power Output	Internally limited, 36W typical	
Soldering temperature	300°C for 10 seconds	
	Recommended Operating temperature	-55°C to +85°C
Temperature Range ¹	Maximum Operating temperature	-55°C to +115°C
	Storage case temperature	-65°C to +135°C

		1						
212115	Condition $ -55^{\circ}C \leq TC \leq +85^{\circ}C, \ V_{IN} = 28 \ V_{DC} \\ \pm 5\%, \ CL=0, \ unless \ otherwise $	ATR2812D			ATR2815D			
PARAMETER	specified	Min	Тур	Max	Min	Тур	Max	Units
STATIC CHARACTERISTICS								
OUTPUT	$V_{IN} = 16 \text{ to } 40 \text{ V}_{DC}$							
Voltage	I _{OUT} = 0 to Full Load	±11.76	±12	±12.24	±14.70	±15	±15.30	V _{DC}
Current 5		0.0		±1.25	0.0		±1.0	A _{DC}
Ripple	Full Load, 20KHz to 2MHz		40	85		40	85	mV p-p
Accuracy	T _{CASE} = 25°C, Full Load	±11.88	±12	±12.12	±14.85	±15.00	±15.15	V _{DC}
Power ¹		30			30			W
REGULATION								
Line	$V_{IN} = 16 \text{ to } 40 \text{ V}_{DC}$			75			75	mV
Load	I _{OUT} = 0 to Full Load			120			150	mV
CROSS REGULATION ⁶	$V_{IN} = 16, 28, and 40 V_{DC}$			±5			±5	%
INPUT								
Voltage Range		16	28	40	16	28	40	V _{DC}
Current	No Load, pin 2 = open			75			75	mA _{DC}
	Inhibited, pin 2 tied to pin 10			18			18	mA _{DC}
Ripple Current	Full Load		25	50		25	50	mA p-p
EFFICIENCY	Full Load T _C = +25°C		82			82		%
ISOLATION	Input to output @500 V _{DC}	100			100			MΩ
CAPACITIVE LOAD	No effect on performance $T_C = +25^{\circ}C \text{ (total for both outputs)}$			100			100	μF
Load Fault Power Dissipation	Short Circuit			9.0			9.0	W
	Overload, T _C = +25°C			14			14	W
Switching Frequency	I _{OUT} = Full Load	500		600	500		600	KHz
SYNC Frequency Range ⁷		500		700	500		700	KHz
DYNAMIC CHARACTERISTICS								
Step Load Changes								
Output	50% Load to 100% Load		±100			±100		mVpk
Transient	No Load to 50% Load		±250			±250		mVpk
_ 2								
Recovery ²	50% Load to 100% Load		25			25		μs
	No Load to 50% Load		500			500		μs
	50% Load to No Load		3.0			3.0		ms
Step Line Changes								
Output	Input step 16 to 40 V _{DC}		±180			±180		mVpk
Transient	Input step 40 to 16 V _{DC}		-600			-600		mVpk
Recovery ²	Input step 16 to 40 V _{DC}		5.0			5.0		ms
TURNION	Input step 40 to 16 V _{DC}	1	5.0	1		5.0		ms
TURN-ON								
Overshoot	$V_{IN} = 16 \text{ to } 40 \text{ V}_{DC}$		0.0	600		0.0	600	mVpk
Delay ³	I _{OUT} = O and Full Load	-	14	25		14	25	ms
Load Fault Recovery	$V_{IN} = 16 \text{ to } 40 \text{ V}_{DC}$		14	25		14	25	ms

Notes to Specifications

- 1. Above +85°C case temperature, derate output power linearly to 0 at +115°C case.
- 2. Recovery time is measured from the initiation of the input transient to where V_{out} has returned to within $\pm 1\%$ of V_{out} at 50% load. 3. Turn-on delay time measurement is for either an application of power at the input or a signal at the inhibit pin.

- Load current split equally between +V_{OUT} and -V_{OUT}.
 Up to 90% of Full Power is available from either output provided. The total power output does not exceed 30W.
- 6. 3W load on output under test, 3W to 27W on other output.
- 7. Sync. Input signal: V_{IL} = -0.5V Min, 0.8V Max and V_{IN} = 2.5V Min, 11.5V Max for 10% to 90% duty cycle.



 $T_{CASE} = -55^{\circ}C$ to +125°C, $V_{IN} = +28V \pm 5\%$ unless otherwise specified

07.02		
Absolute Maximum Ratin	gs	
Input voltage	-0.5V to +50VDC	
Power Output	Internally limited, 36W typical	
Soldering temperature	300°C for 10 seconds	
	Recommended Operating temperature	-55°C to +125°C
Temperature Range ¹	Maximum Operating temperature	-55°C to +135°C
	Storage case temperature	-65°C to +135°C

	Condition $-55^{\circ}\text{C} \le \text{TC} \le +125^{\circ}\text{C}, V_{\text{IN}} = 28$ $V_{\text{DG}} \pm 5\%, \text{CL=0}, \text{unless}$	ATR2812D/ES			ATR2815D/ES			
PARAMETER	otherwise specified	Min	Тур	Max	Min	Тур	Max	Units
STATIC CHARACTERISTICS								
OUTPUT	$V_{IN} = 16 \text{ to } 40 \text{ V}_{DC}$							
Voltage	I _{OUT} = 0 to Full Load	±11.76	±12	±12.24	±14.70	±15	±15	V_{DC}
Current 5		0.0		±1.25	0.0		±1.0	A _{DC}
Ripple	Full Load, 20KHz to 2MHz		40	85		40	85	mV p-p
Accuracy	T _{CASE} = 25°C, Full Load	±11.88	±12.00	±12.12	±14.85	±15.00	±15.15	V_{DC}
Power ¹	,	30			30			W
REGULATION								
Line	$V_{IN} = 16 \text{ to } 40 \text{ V}_{DC}$			75			75	mV
Load	I _{OUT} = 0 to Full Load			120			150	mV
CROSS REGULATION ⁶	$V_{IN} = 16, 28, and 40 V_{DC}$			±5			±5	%
INPUT								
Voltage Range		16	28	40	16	28	40	V _{DC}
Current	No Load, pin 2 = open			75			75	mA _{DC}
	Inhibited, pin 2 tied to pin 10			18			18	mA _{DC}
Ripple Current	Full Load		25	50		25	50	mA p-
EFFICIENCY	Full Load T _C = +25°C	80	82		79	82		%
ISOLATION	Input to output @ 500 V _{DC}	100			100			$M\Omega$
CAPACITIVE LOAD	No effect on performance			100			100	μF
	$T_C = +25^{\circ}C$ (total for both							
	outputs)							
Load Fault Power Dissipation	Short Circuit			9.0			9.0	W
	Overload, T _C = +25°C			14			14	W
Switching Frequency	I _{OUT} = Full Load	500		600	500		600	KHz
SYNC Frequency Range ⁷		500		700	500		700	KHz
DYNAMIC CHARACTERISTICS								
Step Load Changes								
Output	50% Load to 100% Load		±100			±100		mVpk
Transient	No Load to 50% Load		±250			±250		mVpk
	500/ 1 1 1000/ 1 1							
Recovery ²	50% Load to 100% Load		25			25		μs
	No Load to 50% Load 50% Load to No Load		500			500		μs
	50% Load to No Load		3.0		1	3.0		ms
Step Line Changes	Innut ston 10 to 10 V	1	1400					\/\-
Output	Input step 16 to 40 V _{DC}	1	±180			±180		mVpk
Transient	Input step 40 to 16 V _{DC}	1	-600			-600		mVpk
Recovery ²	Input step 16 to 40 V _{DC}	1	5.0			5.0		ms ms
TURN-ON	Input step 40 to 16 V _{DC}		5.0			5.0		IIIS
Overshoot	V = 16 to 40 V	1	0.0	600		0.0	600	m\/rl
Delay ³	$V_{IN} = 16 \text{ to } 40 \text{ V}_{DC}$	1	14	600		14	600	mVpk
Delay	I _{OUT} = O to Full Load V _{IN} = 16 to 40 V _{DC}		14	25 25		14	25	ms

Notes to Specifications

- 1. Above +125°C case temperature, derate output power linearly to 0 at +135°C case.
- Above +125 C case temperature, defaite output power linearly to 0 at +135 C case.
 Recovery time is measured from the initiation of the input transient to where V_{OUT} has returned to within ±1% of V_{OUT} at 50% load.
 Turn-on delay time measurement is for either an application of power at the input or a signal at the inhibit pin.
 Load current split equally between +V_{OUT} and -V_{OUT}.
 Up to 90% of Full Power is available from either output provided. The total power output does not exceed 30W.
 3W load on output under test, 3W to 27W on other output.
 Sync. Input signal: V_{IL} = -0.5V Min, 0.8V Max and V_{IN} = 2.5V Min, 11.5V Max for 10% to 90% duty cycle.

 $T_{CASE} = -55^{\circ}C$ to +125°C, $V_{IN} = +28V \pm 5\%$ unless otherwise specified

Absolute Maximum Rating	gs	
Input voltage	-0.5V to +50VDC	
Power Output	Internally limited, 36W typical	
Soldering temperature	300°C for 10 seconds	
	Recommended Operating temperature	-55°C to +125°C
Temperature Range ¹	Maximum Operating temperature	-55°C to +135°C
	Storage case temperature	-65°C to +135°C

	T	1			1			
DADAMETER	Condition -55°C ≤ TC ≤ +125°C, $V_{\mathbb{N}}$ = 28 $V_{\mathbb{DC}}$ ±5%, CL=0, unless otherwise	ATR2812D/HB			ATR2815D/HB			
PARAMETER	specified	Min	Тур	Max	Min	Тур	Max	Units
STATIC CHARACTERISTICS								
OUTPUT	$V_{IN} = 16 \text{ to } 40 \text{ V}_{DC}$							
Voltage	I _{OUT} = 0 to Full Load	±11.76	±12.00	±12.24	±14.70	±15	±15.30	V _{DC}
Current 5		0.0		±1.25	0.0		±1.0	A _{DC}
Ripple	Full Load, 20KHz to 2MHz		40	85		40	85	mV p-p
Accuracy	T _{CASE} = 25°C, Full Load	±11.88	±12.00	±12.12	±14.85	±15.00	±15.15	V _{DC}
Power ¹		30			30			W
REGULATION								
Line ⁴	$V_{IN} = 16 \text{ to } 40 \text{ V}_{DC}$			75			75	mV
Load ⁴	I _{OUT} = 0 to Full Load			120			150	mV
CROSS REGULATION ⁶	$V_{IN} = 16, 28, and 40 V_{DC}$			±5			±5	%
INPUT								
Voltage Range		16	28	40	16	28	40	V _{DC}
Current	No Load, pin 2 = open			75		18	75	mA _{DC}
	Inhibited, pin 2 tied to pin 10			18			18	mA _{DC}
Ripple Current	Full Load		25	50		25	50	mA p-p
EFFICIENCY	Full Load T _C = +25°C	80	82		79	82		%
ISOLATION	Input to output @ 500 V _{DC}	100			100			MΩ
CAPACITIVE LOAD	No effect on performance $T_C = +25^{\circ}C \text{ (total for both outputs)}$			100			100	μF
Load Fault Power Dissipation	Short Circuit			9.0			9.0	W
	Overload, T _C = +25°C			14			14	W
Switching Frequency	I _{OUT} = Full Load	500		600	500		600	KHz
SYNC Frequency Range ⁷	00,	500		700	500		700	KHz
DYNAMIC CHARACTERISTICS								
Step Load Changes								
Output ⁴	50% Load to 100% Load	ĺ	±100	±450		±100	±450	mVpk
Transient	No Load to 50% Load		±250	±760		±250	±750	mVpk
Recovery ²	50% Load to 100% Load		25	70		25	70	μς
ı	No Load to 50% Load		500	1500		500	1500	μs
	50% Load to No Load		3.0	5.0		3.0	5.0	ms
Step Line Changes								
Output	Input step 16 to 40 V _{DC}		±180	1200		±180	1500	mVpk
Transient	Input step 40 to 16 V _{DC}		-600	-1500		-600	-1500	mVpk
Recovery ²	Input step 16 to 40 V _{DC}		5.0	10		5.0	10	ms
	Input step 40 to 16 V _{DC}		5.0	10		5.0	10	ms
TURN-ON								
Overshoot	$V_{IN} = 16 \text{ to } 40 \text{ V}_{DC}$		0.0	600		0.0	600	mVpk
Delay ³	I _{OUT} = O to Full Load	ļ	14	25		14	25	ms
Load Fault Recovery	$V_{IN} = 16 \text{ to } 40 \text{ V}_{DC}$	1	14	25		14	25	ms

- 1. Above +125°C case temperature, derate output power linearly to 0 at +135°C case.
- Above +125°C case temperature, derate output power linearly to 0 at +135°C case.
 Recovery time is measured from the initiation of the input transient to where V_{OUT} has returned to within ±1% of V_{OUT} at 50% load.
 Turn-on delay time measurement is for either an application of power at the input or a signal at the inhibit pin.
 Load current split equally between +V_{OUT} and -V_{OUT}.
 Up to 90% of Full Power is available from either output provided. The total power output does not exceed 30W.
 3W load on output under test, 3W to 27W on other output.
 Sync. Input signal: V_{IL} = -0.5V Min, 0.8V Max and V_{IN} = 2.5V Min, 11.5V Max for 10% to 90% duty cycle.



 $T_{CASE} = -55$ °C to +125°C, $V_{IN} = +28V \pm 5\%$ unless otherwise specified

CASE	·	
Absolute Maximum Rating	gs	
Input voltage	-0.5V to +50VDC	
Power Output	Internally limited, 36W typical	
Soldering temperature	300°C for 10 seconds	
	Recommended Operating temperature	-55°C to +125°C
Temperature Range ¹	Maximum Operating temperature	-55°C to +135°C
	Storage case temperature	-65°C to +135°C

		_						1
DADAMETER	Condition $ -55^{\circ}\text{C} \leq \text{TC} \leq +125^{\circ}\text{C}, \ V_{\text{IN}} = 28 \ V_{\text{DC}} \\ \pm 5\%, \ \text{CL=0}, \ \text{unless otherwise} $	ATR2812D/CH			ATR2815D/CH			
PARAMETER	specified	Min	Тур	Max	Min	Тур	Max	Units
STATIC CHARACTERISTICS								
OUTPUT	$V_{IN} = 16$ to 40 V_{DC}							
Voltage	I _{OUT} = 0 to Full Load	±11.76	±12.00	±12.24	±14.70	±15	±15.30	V _{DC}
Current 5		0.0		±1.25	0.0		±1.0	A _{DC}
Ripple	Full Load, 20KHz to 2MHz	1	40	85		40	85	mV p-p
Accuracy	T _{CASE} = 25°C, Full Load	±11.88	±12.00	±12.12	±14.85	±15.00	±15.15	V _{DC}
Power ¹		30		ĺ	30			W
REGULATION								
Line⁴	$V_{IN} = 16 \text{ to } 40 \text{ V}_{DC}$			75			75	mV
Load ⁴	I _{OUT} = 0 to Full Load			120			150	mV
CROSS REGULATION ⁶	$V_{IN} = 16, 28, and 40 V_{DC}$			±5			±5	%
INPUT								
Voltage Range		16	28	40	16	28	40	V _{DC}
Current	No Load, pin 2 = open			75		18	75	mA _{DC}
	Inhibited, pin 2 tied to pin 10			18			18	mA _{DC}
Ripple Current	Full Load		25	50		25	50	mA p-p
EFFICIENCY	Full Load T _C = +25°C	80	82		79	82		%
ISOLATION	Input to output @500 V _{DC}	100			100			$M\Omega$
CAPACITIVE LOAD	No effect on performance			100			100	μF
	$T_C = +25^{\circ}C$ (total for both outputs)							
Load Fault Power Dissipation	Short Circuit			9.0			9.0	W
•	Overload, T _C = +25°C			14			14	W
Switching Frequency	I _{OUT} = Full Load	500		600	500		600	KHz
SYNC Frequency Range ⁷	001	500		700	500		700	KHz
DYNAMIC CHARACTERISTICS		İ	ĺ			ĺ		ĺ
Step Load Changes		İ	İ	j	İ			j
Output⁴	50% Load to 100% Load		±100	±450		±100	±450	mVpk
Transient	No Load to 50% Load		±250	±760		±250	±750	mVpk
Recovery ²	50% Load to 100% Load		25	70		25	70	μs
	No Load to 50% Load		500	1500		500	1500	μs
	50% Load to No Load		3.0	5.0		3.0	5.0	ms
Step Line Changes								
Output	Input step 16 to 40 V _{DC}		±180	1200		±180	1500	mVpk
Transient	Input step 40 to 16 V _{DC}		-600	-1500		-600	-1500	mVpk
Recovery ²	Input step 16 to 40 V _{DC}		5.0	10		5.0	10	ms
	Input step 40 to 16 V _{DC}		5.0	10		5.0	10	ms
TURN-ON								
Overshoot	$V_{IN} = 16 \text{ to } 40 \text{ V}_{DC}$		0.0	600		0.0	600	mVpk
Delay ³	I _{OUT} = 0 to Full Load		14	25		14	25	ms
Load Fault Recovery	$V_{IN} = 16 \text{ to } 40 \text{ V}_{DC}$		14	25		14	25	ms

- Notes to Specifications

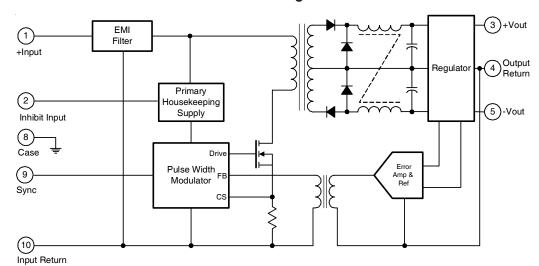
 1. Above +125°C case temperature, derate output power linearly to 0 at +135°C case.
- 2. Recovery time is measured from the initiation of the input transient to where V_{OUT} has returned to within $\pm 1\%$ of V_{OUT} at 50% load. 3. Turn-on delay time measurement is for either an application of power at the input or a signal at the inhibit pin.

- Load current split equally between +V_{OUT} and -V_{OUT}.
 Up to 90% of Full Power is available from either output provided. The total power output does not exceed 30W.
 3W load on output under test, 3W to 27W on other output.
 Sync. Input signal: V_{IL} = -0.5V Min, 0.8V Max and V_{IN} = 2.5V Min, 11.5V Max for 10% to 90% duty cycle.

ATR28XXD Series

International TOR Rectifier

Block Diagram



Application Information

Inhibit Function

Connecting the inhibit input (Pin 2) to input common (Pin 10) will cause the converter to shut down. It is recommended that the inhibit pin be driven by an open collector device capable of sinking at least $400\mu A$ of current. The open circuit voltage of the inhibit input is $11.5 \pm 1.0 \text{VDC}$.

EMI Filter

An EMI filter (AFC461), available as an option, will reduce the input ripple current to levels below the limits imposed by MIL-STD-461B CEO3.

Device Synchronization

Whenever multiple DC/DC converters are utilized in a single system, significant low frequency noise may be generated due to slight difference in the switching frequencies of the converters (beat frequency noise). Because of the low frequency nature of this noise (typically less than 10KHz), it is difficult to filter out and may interfere with proper operation of sensitive systems (communications, radar or telemetry). The International Rectifier ATR28XX converters provide a synchronizing input permitting synchronization of multiple converters to the frequency of the users system clock, thereby minimizing this type of noise.

Thermal Management

Assuming that there is no forced air flow, the package temperature rise above ambient (ΔT) may be calculated using the following expression:

$$\Delta T = 80 \text{ A}^{-0.7} \text{ P}_{d}^{0.85} (^{\circ}\text{C})$$
 (1)

where A = the effective surface area in square inhes (in-cluding heat sink if used), $P_{\rm d}$ = power dissipation in watts.

The total surface area of the ATR standard package is 7.34 square inches. If a worse case full load efficiency of 78% is assumed, then the case temperature rise can be calculated as follows:

$$P_d = P_{OUT} \left[\frac{1}{Eff} - 1 \right] = 30 \left[\frac{1}{78} - 1 \right] = 8.5W$$

and
$$\Delta T = 80 (7.34)^{-0.7} (8.5)^{0.85} = 122^{\circ}C$$

Hence, if $T_{AMBIENT} = +25^{\circ}C$, the DC/DC converter case temperature will be approximately 147°C if no heat sink or air flow is provided.

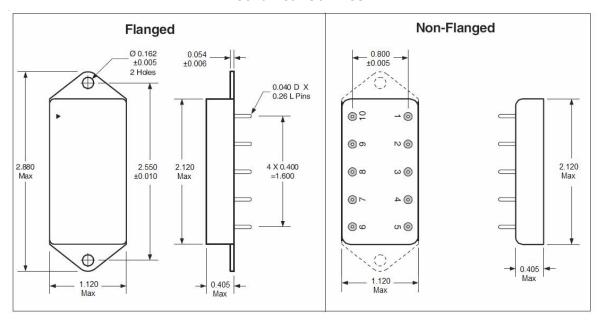
To calculate the heat sink area required to maintain a specific case temperature rise, equation (1) may be manipulated as follows:

$$A_{HEATSINK} = \left[\frac{\Delta T}{80 P_d^{0.85}} \right]^{-1.43} - A_{PKG}$$

As an example, if it is desired to limit the case temperature rise to a maximum of 50°C above ambient, the required effective heat sink area is:

$$A_{HEATSINK} = \left[\frac{50}{80(8.5)^{0.85}} \right]^{-1.43} - 7.34 = 19.1 in^2$$

Mechanical Outlines



Pin Designation

Pin #	Designation			
1	+ Input			
2	Inhibit Input			
3	+ Output			
4	Output Return			
5	- Output			
6	NC			
7	NC			
8	Case Ground			
9	Sync.			
10	Input Return			

Standard Microcircuit Drawing Equivalence Table

Standard Microcircuit	Vendor Cage	IR Standard
Drawing Number	Code	Part Number
5962-94627	52467	ATR2812D
5962-94628	52467	ATR2815D

ATR28XXD Series

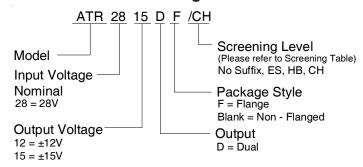
Device Screening

Requirement	MIL-STD-883 Method	No Suffix	ES ②	НВ	СН
Temperature Range	_	-20°C to +85°C	-55°C to +125°C ③	-55°C to +125°C	-55°C to +125°C
Element Evaluation	MIL-PRF-38534	N/A	N/A	N/A	Class H
Non-Destructive	2023	N/A	N/A	N/A	N/A
Bond Pull	2023	IN/A	IN/A	N/A	IN/A
Internal Visual	2017	0	Yes	Yes	Yes
Temperature Cycle	1010	N/A	Cond B	Cond C	Cond C
Constant Acceleration	2001, Y1 Axis	N/A	500 Gs	3000 Gs	3000 Gs
PIND	2020	N/A	N/A	N/A	N/A
Burn-In	1015	N/A	48 hrs@hi temp	160 hrs@125°C	160 hrs@125°C
Final Electrical	MIL-PRF-38534	25°C	25°C ②	-55°C, +25°C,	-55°C, +25°C,
(Group A)	& Specification			+125°C	+125°C
PDA	MIL-PRF-38534	N/A	N/A	N/A	10%
Seal, Fine and Gross	1014	Cond A	Cond A, C	Cond A, C	Cond A, C
Radiographic	2012	N/A	N/A	N/A	N/A
External Visual	2009	①	Yes	Yes	Yes

Notes:

- ① Best commercial practice
- ② Sample tests at low and high temperatures
- 3 -55°C to +105°C for AHE, ATO, ATW

Part Numbering





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